



# MJPE32C-Q

100 V, 3 A PNP high power bipolar transistor

22 April 2025

Product data sheet

## 1. General description

PNP high power bipolar transistor in a power SOT1289B (CFP15B) flat lead Surface-Mounted Device (SMD) plastic package.

NPN complement: MJPE31C-Q

## 2. Features and benefits

- High thermal power dissipation capability
- High energy efficiency due to less heat generation
- Electrically similar to popular MJD32 series
- Low collector emitter saturation voltage
- Qualified according to AEC-Q101 and recommended for use in automotive applications

## 3. Applications

- Power management
- Load switch
- Linear mode voltage regulator
- Constant current drive backlighting application
- Motor drive
- Relay replacement

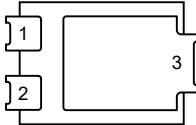
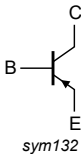
## 4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{CEO}$	collector-emitter voltage	open base	-	-	-100	V
$I_C$	collector current		-	-	-3	A
$I_{CM}$	peak collector current	single pulse; $t_p \leq 1$ ms	-	-	-5	A
$h_{FE}$	DC current gain	$V_{CE} = -4$ V; $I_C = -1$ A; pulsed; $t_p \leq 300$ $\mu$ s; $\delta \leq 0.02$ ; $T_{amb} = 25$ °C	25	-	-	
		$V_{CE} = -4$ V; $I_C = -3$ A; pulsed; $t_p \leq 300$ $\mu$ s; $\delta \leq 0.02$ ; $T_{amb} = 25$ °C	10	-	-	

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	E	emitter	 CFP15B (SOT1289B)	 sym132
2	B	base		
3	C	collector		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
<a href="#">MJPE32C-Q</a>	CFP15B	plastic, thermal enhanced ultra thin SMD package; 3 leads; 2.13 mm pitch; 5.8 x 4.3 x 0.95 mm body	<a href="#">SOT1289B</a>

7. Marking

Table 4. Marking codes

Type number	Marking code
MJPE32C-Q	MJPE32C0

8. Limiting values

Table 5. Limiting values  
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CEO</sub>	collector-emitter voltage	open base		-	-100	V
V <sub>EBO</sub>	emitter-base voltage	open collector		-	-6	V
I <sub>C</sub>	collector current			-	-3	A
I <sub>CM</sub>	peak collector current	single pulse; t <sub>p</sub> ≤ 1 ms		-	-5	A
P <sub>tot</sub>	total power dissipation	T <sub>amb</sub> ≤ 25 °C	[1]	-	1.6	W
		T <sub>amb</sub> ≤ 25 °C	[2]	-	2.2	W
T <sub>j</sub>	junction temperature			-	175	°C
T <sub>amb</sub>	ambient temperature			-55	175	°C
T <sub>stg</sub>	storage temperature			-65	175	°C

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), 140 µm single-sided copper, standard footprint.  
[2] Device mounted on an FR4 Printed-Circuit Board (PCB), 140 µm single-sided copper, mounting pad for collector 1 cm<sup>2</sup>.

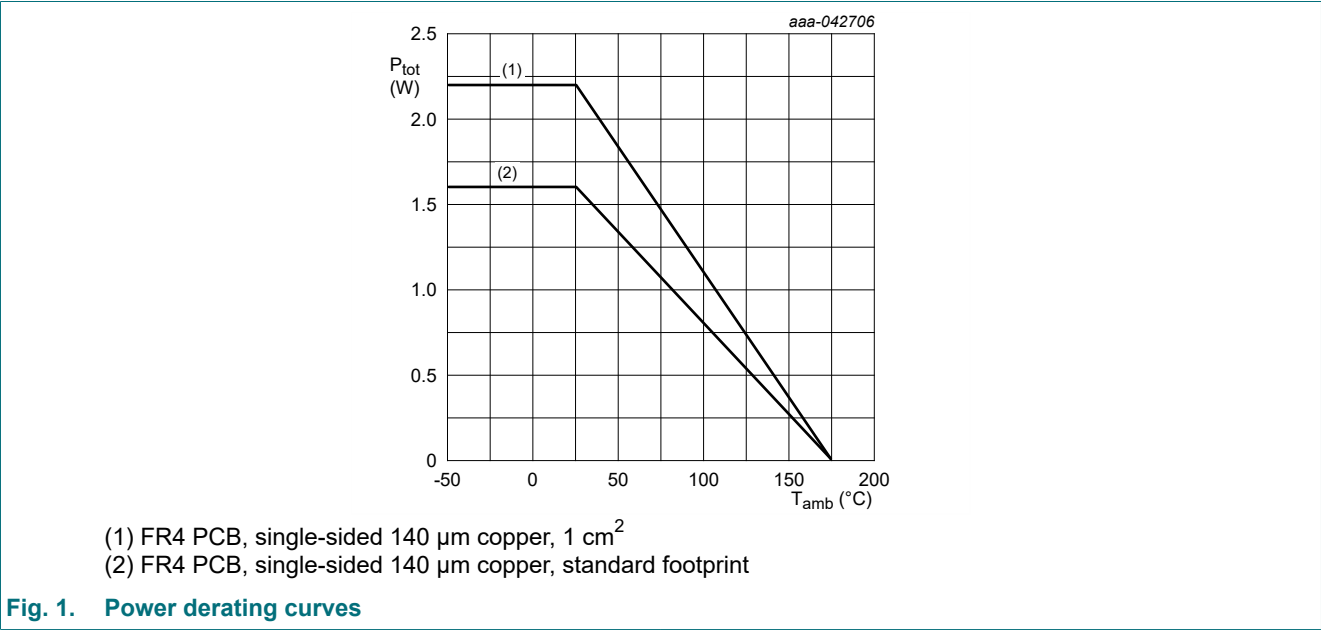


Fig. 1. Power derating curves

9. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	94	K/W
			[2]	-	-	69	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point			-	-	4.5	K/W

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), 140 µm single-sided copper, standard footprint.
- [2] Device mounted on an FR4 Printed-Circuit Board (PCB), 140 µm single-sided copper, mounting pad for collector 1cm<sup>2</sup>.

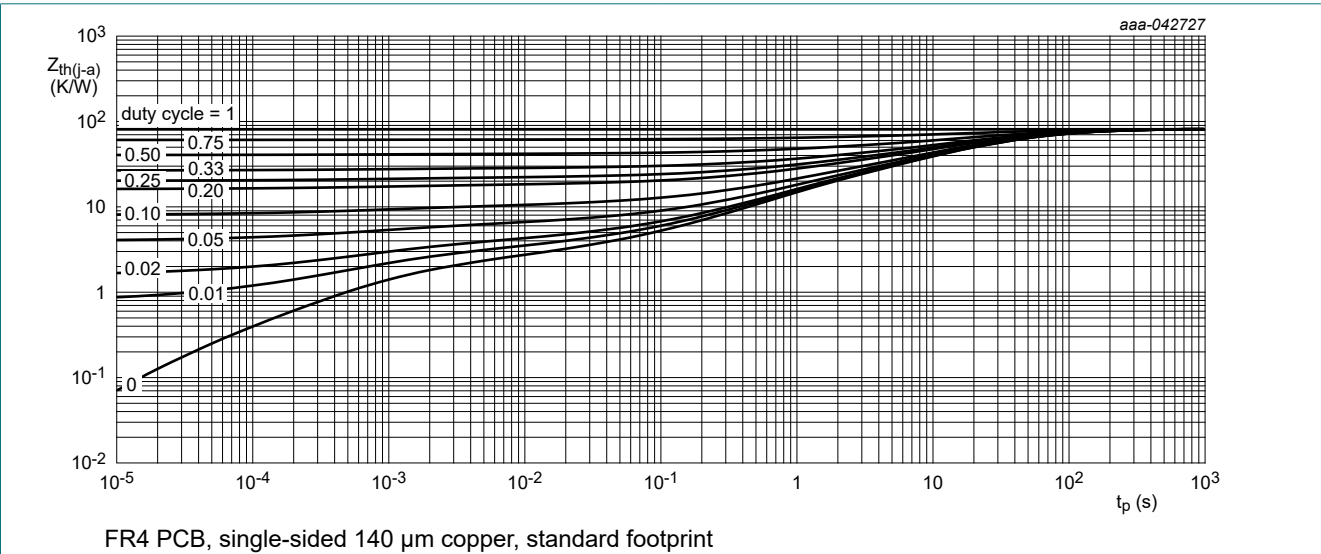


Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

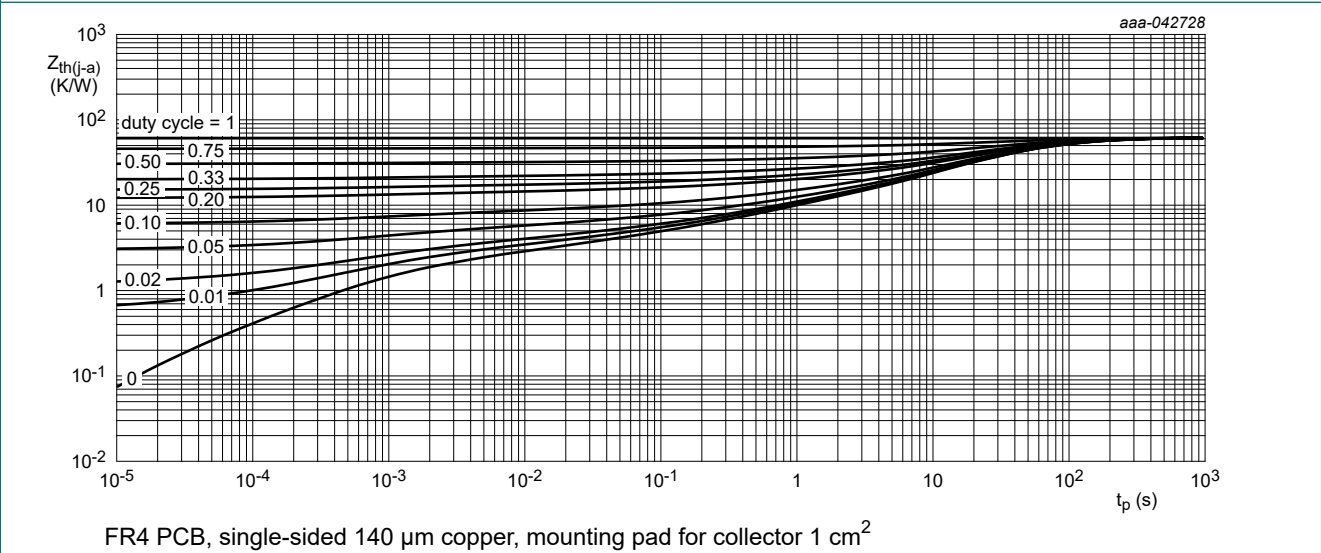
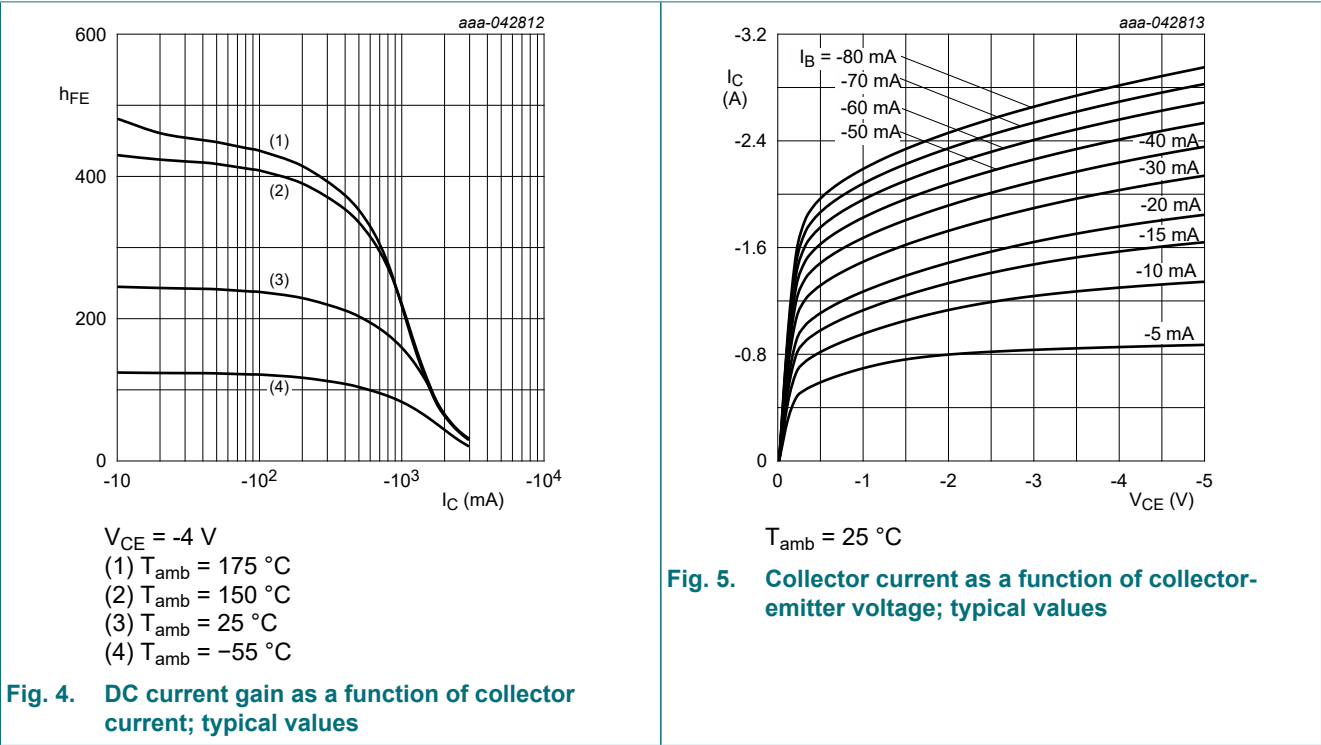


Fig. 3. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{(BR)CEO}$	collector-emitter breakdown voltage	$I_C = -2\text{ mA}$ ; $I_B = 0\text{ A}$ ; $T_{amb} = 25\text{ °C}$	-100	-	-	V
$V_{(BR)EBO}$	emitter-base breakdown voltage	$I_C = 0\text{ A}$ ; $I_E = -100\text{ }\mu\text{A}$ ; $T_{amb} = 25\text{ °C}$	-6	-	-	V
$I_{CBO}$	collector-base cut-off current	$V_{CB} = -80\text{ V}$ ; $I_E = 0\text{ A}$ ; $T_{amb} = 25\text{ °C}$	-	-	-1	$\mu\text{A}$
$I_{CES}$	collector-emitter cut-off current	$V_{CE} = -80\text{ V}$ ; $V_{BE} = 0\text{ V}$ ; $T_{amb} = 25\text{ °C}$	-	-	-1	$\mu\text{A}$
		$V_{CE} = -80\text{ V}$ ; $V_{BE} = 0\text{ V}$ ; $T_J = 150\text{ °C}$	-	-	-50	$\mu\text{A}$
$I_{EBO}$	emitter-base cut-off current	$V_{EB} = -5\text{ V}$ ; $I_C = 0\text{ A}$ ; $T_{amb} = 25\text{ °C}$	-	-	-1	$\mu\text{A}$
$h_{FE}$	DC current gain	$V_{CE} = -4\text{ V}$ ; $I_C = -1\text{ A}$ ; pulsed; $t_p \leq 300\text{ }\mu\text{s}$ ; $\delta \leq 0.02$ ; $T_{amb} = 25\text{ °C}$	25	-	-	
		$V_{CE} = -4\text{ V}$ ; $I_C = -3\text{ A}$ ; pulsed; $t_p \leq 300\text{ }\mu\text{s}$ ; $\delta \leq 0.02$ ; $T_{amb} = 25\text{ °C}$	10	-	-	
$V_{CEsat}$	collector-emitter saturation voltage	$I_C = -3\text{ A}$ ; $I_B = -375\text{ mA}$ ; pulsed; $t_p \leq 300\text{ }\mu\text{s}$ ; $\delta \leq 0.02$ ; $T_{amb} = 25\text{ °C}$	-	-	-1.2	V
$V_{BE}$	base-emitter voltage	$V_{CE} = -4\text{ V}$ ; $I_C = -3\text{ A}$ ; pulsed; $t_p \leq 300\text{ }\mu\text{s}$ ; $\delta \leq 0.02$ ; $T_{amb} = 25\text{ °C}$	-	-	-1.8	V
$h_{fe}$	small-signal current gain	$V_{CE} = -10\text{ V}$ ; $I_C = -500\text{ mA}$ ; $f = 1\text{ kHz}$ ; $T_{amb} = 25\text{ °C}$	20	-	-	
$f_T$	transition frequency	$V_{CE} = -10\text{ V}$ ; $I_C = -500\text{ mA}$ ; $f = 100\text{ MHz}$ ; $T_{amb} = 25\text{ °C}$	3	105	-	MHz



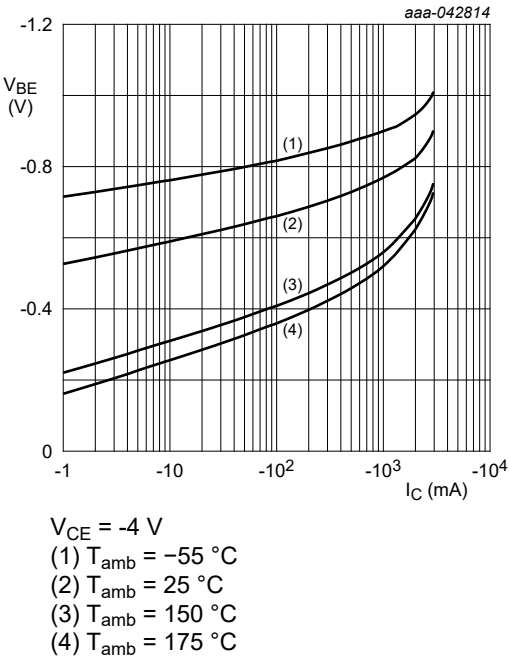


Fig. 6. Base-emitter voltage as a function of collector current; typical values

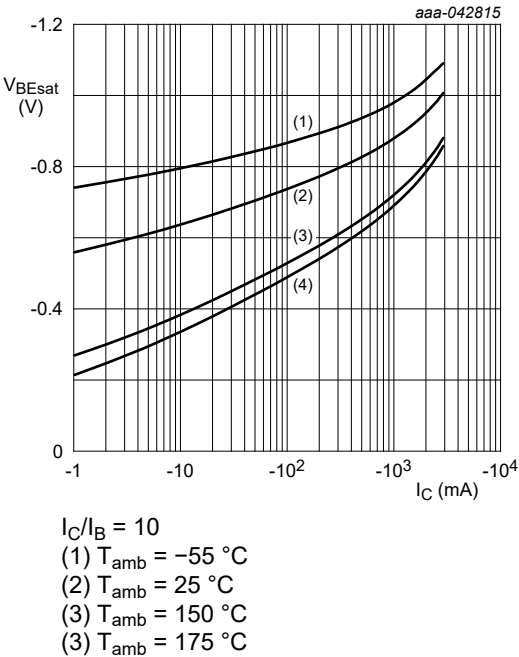


Fig. 7. Base-emitter saturation voltage as a function of collector current; typical values

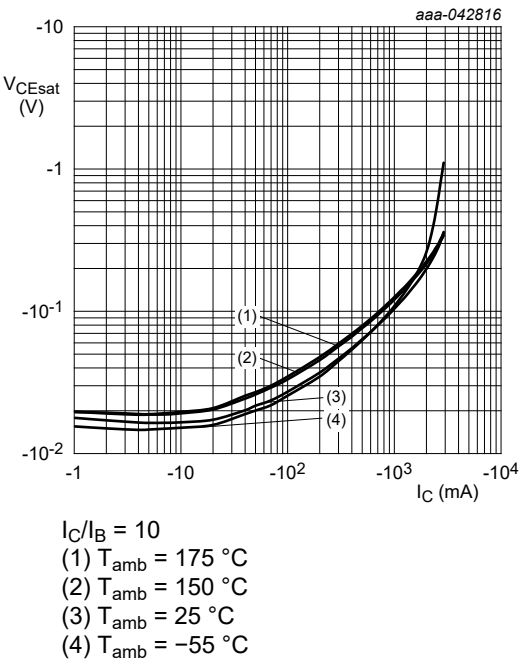


Fig. 8. Collector-emitter saturation voltage as a function of collector current; typical values

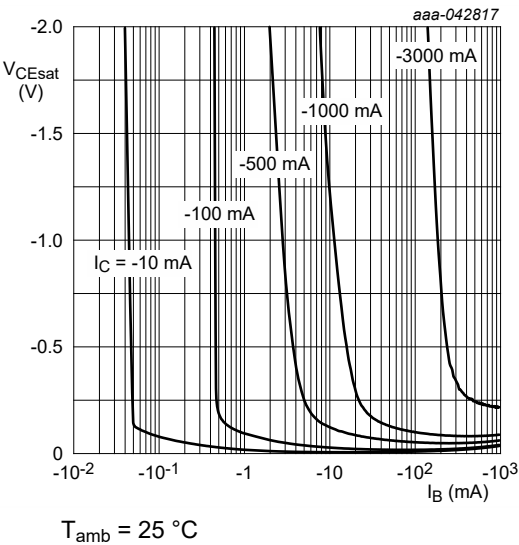
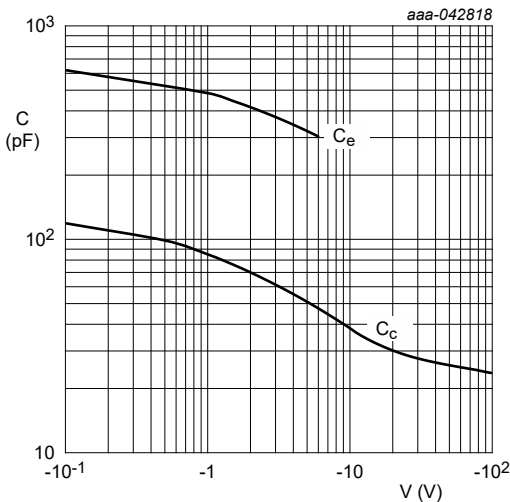


Fig. 9. Collector-emitter saturation region as a function of base current; typical values



T<sub>amb</sub> = 25 °C

Fig. 10. Input/output capacitance as a function of input/output voltage

11. Test information

Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

12. Package outline

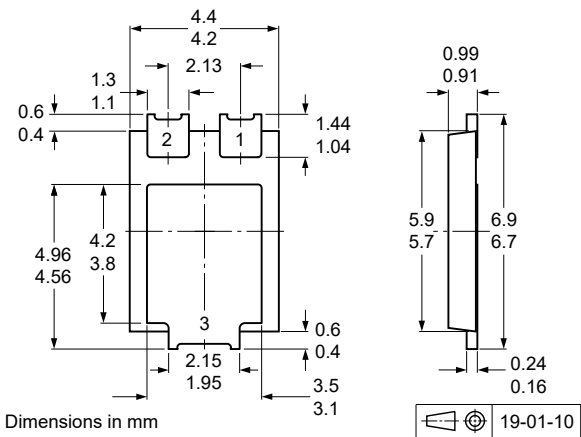


Fig. 11. Package outline CFP15B (SOT1289B)

13. Soldering

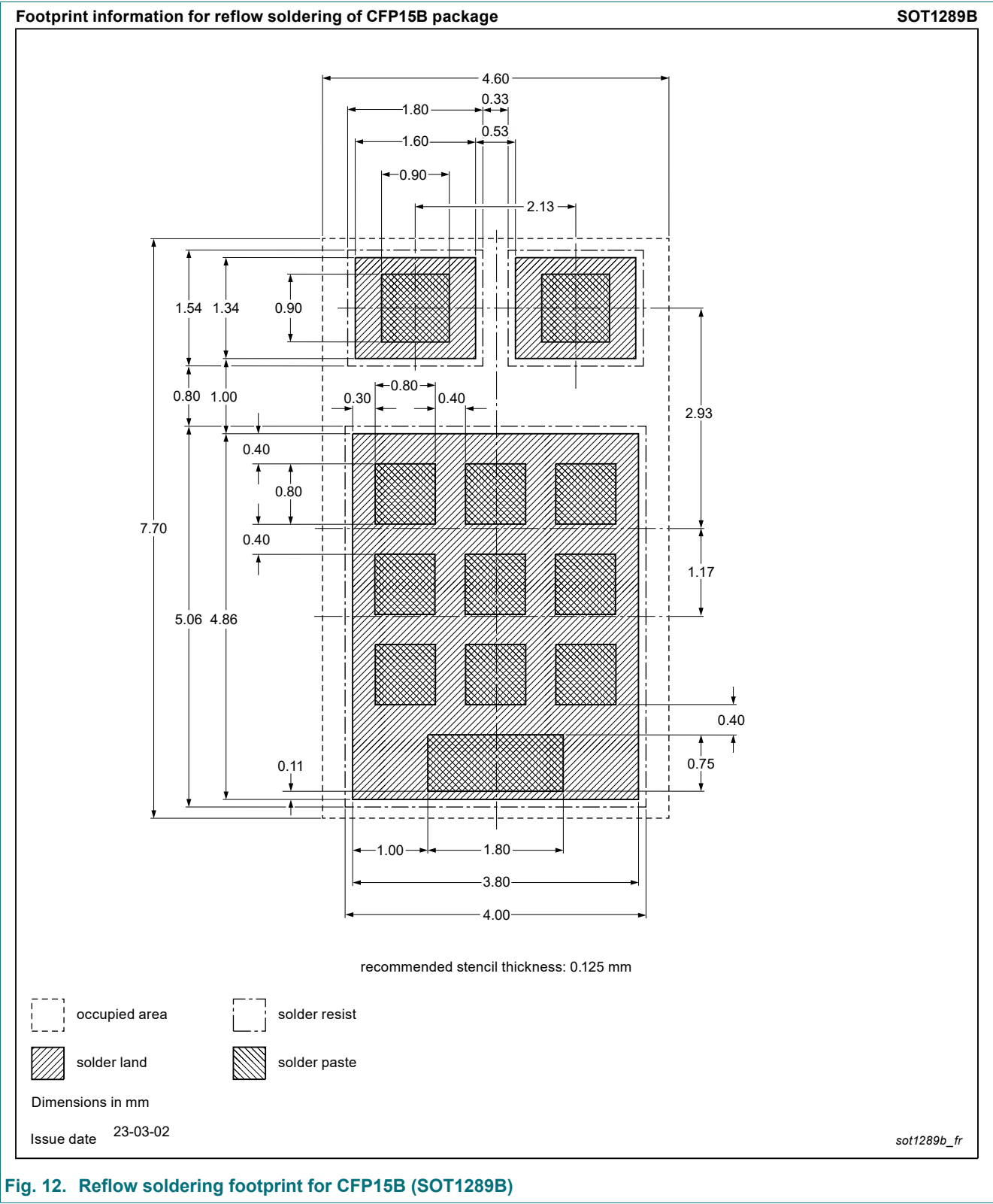


Fig. 12. Reflow soldering footprint for CFP15B (SOT1289B)



14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
MJPE32C-Q v.1	20250422	Product data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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